

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	38	(epoxy or epoxies or polyimide or polyimides or polymeric) near10 (openings or apertures) near10 (etching or etch or lithography or polishing)	USPAT	2002/06/07 15:43

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	1026	(438/613,108,612).CCLS.	USPAT	2002/06/07 14:40
2	BRS	L2	4933	(pattern or patterning) same (openings or apertures) same (lithography or etching or etch or polishing or polish)	USPAT	2002/06/07 15:18
3	BRS	L3	51	1 and 2	USPAT	2002/06/07 14:42
4	BRS	L4	118	(pattern or patterning) same (openings or apertures) same (lithography or etching or etch or polishing or polish) same (polymeric or polymeric or polyimide or polyimides or epoxy or epoxies)	USPAT	2002/06/07 15:18
5	BRS	L5	4	1 and 4	USPAT	2002/06/07 14:44
6	BRS	L6	114	(pattern or patterning) same (openings or apertures) same (lithography or etching or etch or polishing or polish) same (polymeric or polymeric or polyimide or polyimides or epoxy or epoxies) same (openings or apertures) same (lithography or etching or polishing)	USPAT	2002/06/07 15:20

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	2103	(pattern or patterning) same (polymeric or polymides or epoxy or epoxies or polyimide) same (lithography or etching or polishing)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/06/07 14:31
2	BRS	L2	4	(pattern or patterning) near10 (polymeric or polymides or epoxy or epoxies or polyimide) near10 (lithography or etching or polishing) near10 (apertures or openings)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/06/07 14:32

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	424	(438/613).CCLS.	USPAT	2002/06/07 17:52
2	IS&R	L2	382	(438/108).CCLS.	USPAT	2002/06/07 18:16
3	IS&R	L3	483	(438/612).CCLS.	USPAT	2002/06/07 18:16